

FIG.		
BY	CLASS	SUBCLASS
DRAFTSMAN		

Title: WAFER HEAT-TREATMENT
SYSTEM AND WAFER
HEAT-TREATMENT METHOD
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DOCKET NO.: 025311-0115

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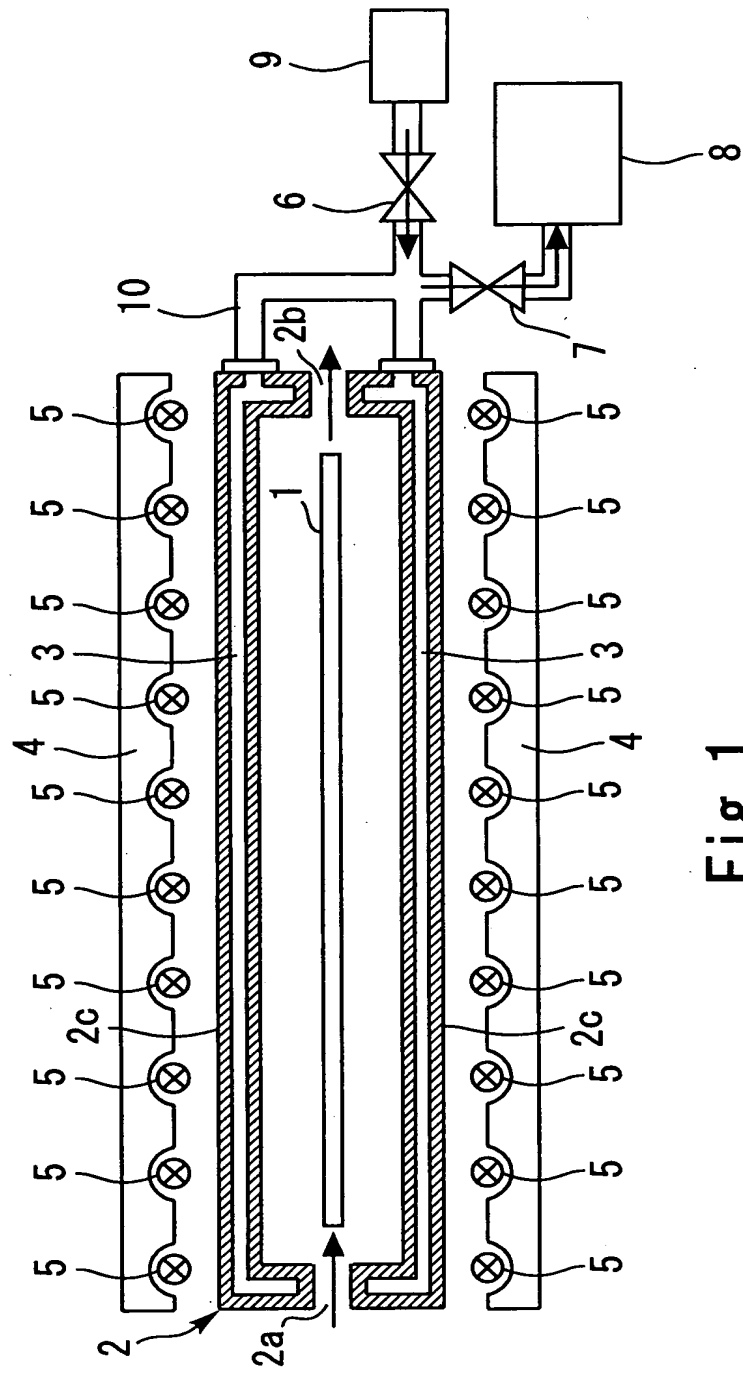
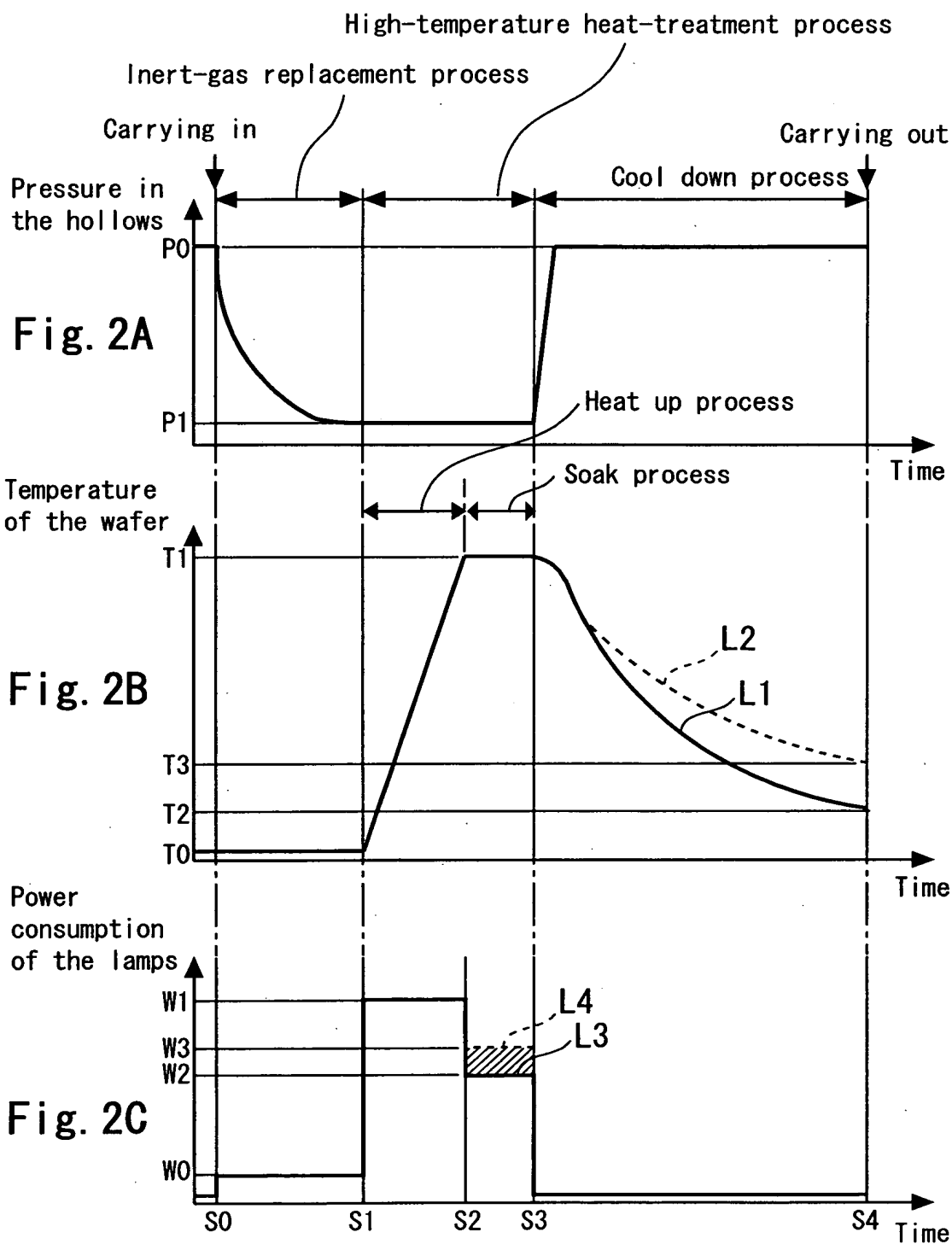
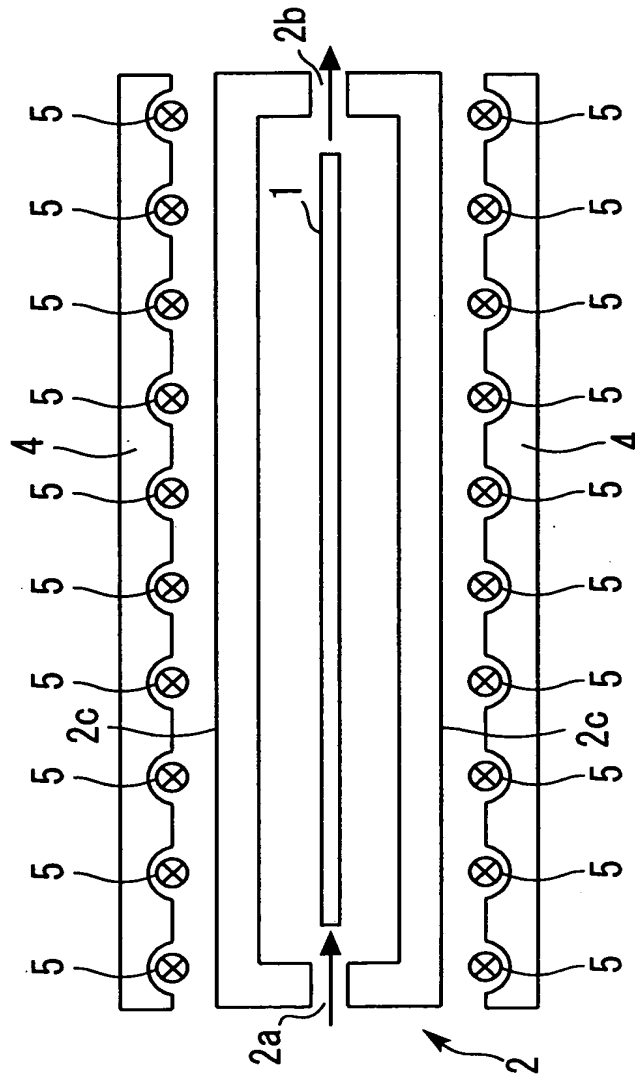


Fig. 1

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